Flip-Chips·CSP Integrated Package 倒装芯片·CSP集成封装 Bicolor CSP Integrated COBs 双色CSP集成COB光源

Main Applications:

主要应用领域:

- ✓ directional projection and beam lighting with small angle for projection, light beam, dyeing, pattern, audience, business, hotel, museum, etc. 小角度方向性投射类照明,适用于投射,光束,染色,图案,观众,商业,酒店,博物馆等
- ✓ intelligent color-mixing lighting 智能混色照明
- ✓ over broader CCT range with higher Ra for lighting of high-end business, stage, studio, photography etc.

 宽色温范围高显指照明,适用于高端商业、舞台、影视、摄影等



Main Parameters	Typical Values
Voltage (V)	WW 18, CW 18
Current (mA)	WW 350, CW 350
Max. Power (W) Note	16 in total
LES (mm)	6.5
CCT (K) /Ra	2870-3220 / >95 6020-7040 / >90
Color / Dominant Wavelength (nm)	N/A
Matched Cu Board	N/A

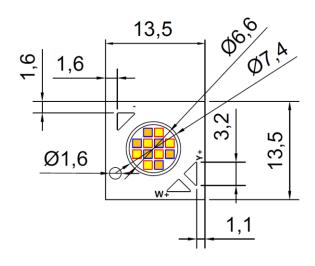
Main Features

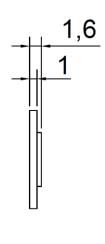
Low Power Bicolor CSP Integrated COB;

CSP Integrated Layout for Excellent Color Uniformity;

Flip Chips with No Gold Wires for High Integration & Good Reliability;

Customizing Other Power, LES, Color Combination, CCT and Ra;







Main Parameters	Typical Values
Voltage (V)	WW 36, CW 36
Current (mA)	WW 350, CW 350
Max. Power (W) Note	33 in total
LES (mm)	10
CCT (K) /Ra	2870-3220 / >95 6020-7040 / >90
Color / Dominant Wavelength (nm)	N/A
Matched Cu Board	N/A

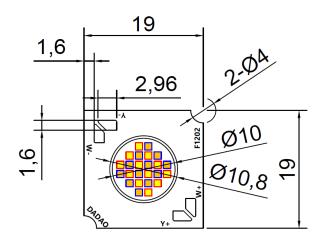
Main Features

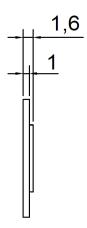
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Main Parameters	Typical Values
Voltage (V)	WW 36, CW 36
Current (mA)	WW 700, CW 700
Max. Power (W) Note	66 in total
LES (mm)	13
CCT (K) /Ra	2870-3220/>95 6020-7040/>90
Color / Dominant Wavelength (nm)	N/A
Matched Cu Board	N/A

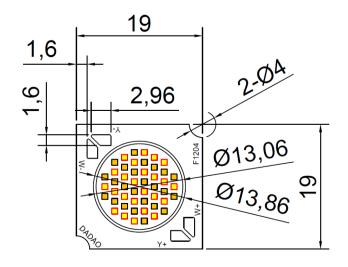
Main Features

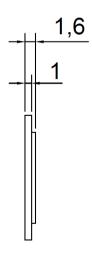
Middle Power Bicolor CSP Integrated COB;

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Main Parameters	Typical Values
Voltage (V)	WW 36, CW 36
Current (mA)	WW 1750, CW 1750
Max. Power (W) Note	164 in total
LES (mm)	22
CCT (K) /Ra	2870-3220 / >95 6020-7040 / >90
Color / Dominant Wavelength (nm)	N/A
Matched Cu Board	N/A

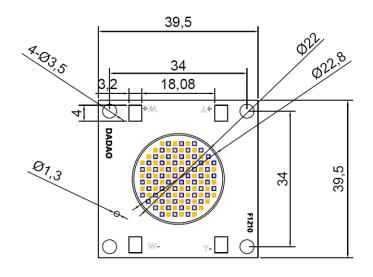
Main Features

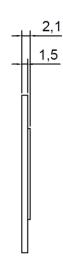
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Main Parameters	Typical Values
Voltage (V)	WW 36, CW 36
Current (mA)	WW 2275, CW 2275
Max. Power (W) Note	213 in total
LES (mm)	24
CCT (K) /Ra	2870-3220 / >95 6020-7040 / >90
Color / Dominant Wavelength (nm)	N/A
Matched Cu Board	N/A

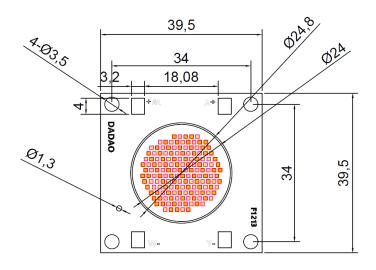
Main Features

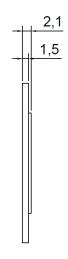
High Power Bicolor CSP Integrated COB;

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Main Parameters	Typical Values
Voltage (V)	WW 36, CW 36
Current (mA)	WW 3150, CW 3150
Max. Power (W) Note	295 in total
LES (mm)	29.2
CCT (K) /Ra	2870-3220 / >95 6020-7040 / >90
Color / Dominant Wavelength (nm)	N/A
Matched Cu Board	N/A

Main Features

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